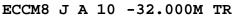
ECCM8JA10-32.000M TR



L Packaging Options Tape & Reel





Frequency Tolerance/Stability ±15ppm at 25°C, ±30ppm over -40°C to +85°C

Mode of Operation AT-Cut Fundamental

Nominal Frequency 32.000MHz Load Capacitance

10pF Parallel Resonant

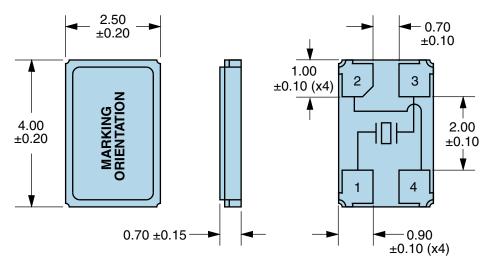
ELECTRICAL SPECIFICATIONS

Nominal Frequency	32.000MHz
Frequency Tolerance/Stability	±15ppm at 25°C, ±30ppm over -40°C to +85°C
Aging at 25°C	±3ppm/Year Maximum
Load Capacitance	10pF Parallel Resonant
Shunt Capacitance (C0)	5pF Maximum
Equivalent Series Resistance	60 Ohms Maximum
Mode of Operation	AT-Cut Fundamental
Drive Level	100µWatts Maximum, 10µWatts Correlation
Crystal Cut	AT-Cut
Spurious Response	>3dB from Fo to Fo+5000ppm
Drive Level Dependancy (DLD2)	20% of Maximum ESR Limit (from 1µWatt to 100µWatt)
Insulation Resistance	500 Megaohms Minimum at 100Vdc

ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

ESD Susceptibility	MIL-STD-883, Method 3015, Class 1, HBM: 1500V
Fine Leak Test	MIL-STD-883, Method 1014, Condition A
Flammability	UL94-V0
Gross Leak Test	MIL-STD-883, Method 1014, Condition C
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Moisture Resistance	MIL-STD-883, Method 1004
Moisture Sensitivity	J-STD-020, MSL 1
Resistance to Soldering Heat	MIL-STD-202, Method 210, Condition K
Resistance to Solvents	MIL-STD-202, Method 215
Solderability	MIL-STD-883, Method 2003
Temperature Cycling	MIL-STD-883, Method 1010, Condition B
Vibration	MIL-STD-883, Method 2007, Condition A

MECHANICAL DIMENSIONS (all dimensions in millimeters)



PIN	CONNECTION
1	Crystal
2	Cover/Ground
3	Crystal
4	Cover/Ground
LINE	MARKING
LINE 1	MARKING E32.0 E=Ecliptek